

May 1999 Revised September 1999

GTLP18T612 18-Bit LVTTL/GTLP Universal Bus Transceiver

General Description

The GTLP18T612 is an 18-bit universal bus transceiver which provides LVTTL to GTLP signal level translation. It allows for transparent, latched and clocked modes of data transfer. The device provides a high speed interface for cards operating at LVTTL logic levels and a backplane operating at GTLP logic levels. High speed backplane operation is a direct result of GTLP's reduced output swing (< 1V), reduced input threshold levels and output edge rate control. The edge rate control minimizes bus settling time. GTLP is a Fairchild Semiconductor derivative of the Gunning Transistor logic (GTL) JEDEC standard JESD8-3.

Fairchild's GTLP has internal edge-rate control and is Process, Voltage, and Temperature (PVT) compensated. Its function is similar to BTL or GTL but with different output levels and receiver thresholds. GTLP output LOW level is less than 0.5V, the output HIGH is 1.5V and the receiver threshold is 1.0V.

Features

- Bidirectional interface between GTLP and LVTTL logic levels
- Edge Rate Control to minimize noise on the GTLP port
- Power up/down high impedance for live insertion
- External V_{REF} pin for receiver threshold
- BiCMOS technology for low power dissipation
- Bushold data inputs on A Port eliminates the need for external pull-up resistors for unused inputs
- LVTTL compatible Driver and Control inputs
- Flow-through architecture optimizes PCB layout
- Open drain on GTLP to support wired-or connection
- A-Port source/sink -24 mA/+24 mA
- B-Port sink capability +50 mA
- D-type flip-flop, latch and transparent data paths

Ordering Code:

Order Number	Package Number	Package Description
GTLP18T612MEA	MS56A	56-Lead Shrink Small Outline Package (SSOP), JEDEC MO-118, 0.300" Wide
GTI P18T612MTD	MTD56	56-Lead Thin Shrink Small Outline Package (TSSOP) JEDEC MO-153, 6.1mm Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

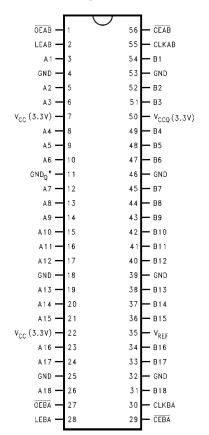
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DS500169

Pin Descriptions

Pin Names	Description
OEAB	A-to-B Output Enable (Active LOW) (LVTTL Level)
OEBA	B-to-A Output Enable (Active LOW) (LVTTL Level)
CEAB	A-to-B Clock/LE Enable (Active LOW) (LVTTL Level)
CEBA	B-to-A Clock/LE Enable (Active LOW) (LVTTL Level)
LEAB	A-to-B Latch Enable (Transparent HIGH) (LVTTL Level)
LEBA	B-to-A Latch Enable (Transparent HIGH) (LVTTL Level)
V_{REF}	GTLP Input Threshold Reference Voltage
CLKAB	A-to-B Clock (LVTTL Level)
CLKBA	B-to-A Clock (LVTTL Level)
A1–A18	A-to-B Data Inputs or B-to-A 3-STATE Outputs
B1-B18	B-to-A Data Inputs or A-to-B Open Drain Outputs

Connection Diagram



Functional Description

The GTLP18T612 is an 18 bit registered transceiver containing D-type flip-flop, latch and transparent modes of operation for the data path. Data flow in each direction is controlled by the clock enables (CEAB and CEBA), latch enables (LEAB and LEBA), clock (CLKAB and CLKBA) and output enables (OEAB and OEBA). The clock enables (CEAB and CEBA) and the output enables (OEAB and OEBA) control the 18 bits of data for the A-to-B and B-to-A directions respectively.

For A-to-B data flow, when $\overline{\text{CEAB}}$ is LOW, the device operates on the LOW-to-HIGH transition of CLKAB for the flip-flop and on the HIGH-to-LOW transition of LEAB for the latch path. That is, if $\overline{\text{CEAB}}$ is LOW and LEAB is LOW the A data is latched regardless as to the state of CLKAB (HIGH or LOW) and if LEAB is HIGH the device is in transparent mode. When $\overline{\text{OEAB}}$ is LOW the outputs are active. When $\overline{\text{OEAB}}$ is HIGH the outputs are HIGH impedance. The data flow of B-to-A is similar except that $\overline{\text{CEBA}}$, $\overline{\text{OEBA}}$, $\overline{\text{DEBA}}$, and CLKBA are used.

Truth Table (Note 1)

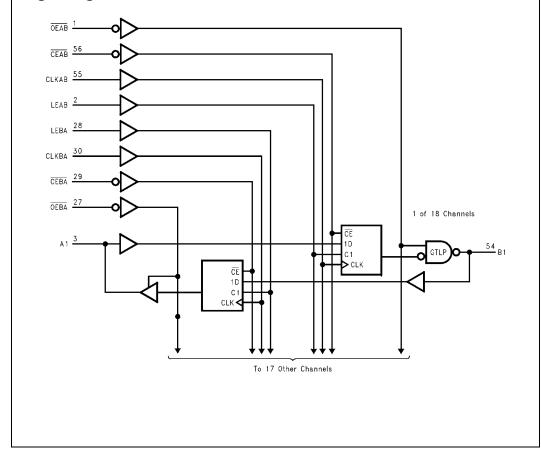
		Output	Mode			
CEAB	OEAB	LEAB	CLKAB	Α	В	
Х	Н	Х	Х	Х	Z	Latched
L	L	L	H or L	Х	B ₀ (Note 2)	storage
L	L	L	H or L	Х	B ₀ (Note 3)	of A data
Х	L	Н	Х	L	L	Transparent
Х	L	Н	Χ	Н	Н	
L	L	L	1	L	L	Clocked
L	L	L	\uparrow	Н	Н	storage
						of A data
Н	L	L	Х	Х	B ₀ (Note 3)	Clock inhibit

 $\textbf{Note 1:} \ A\text{-to-B data flow is shown.} \ B\text{-to-A data flow is similar but uses} \ \overline{\text{OEBA}}, \ LEBA, \ CLKBA, \ and \ \overline{\text{CEBA}}.$

Note 2: Output level before the indicated steady state input conditions were established, provided that CLKAB was HIGH before LEAB went LOW.

Note 3: Output level before the indicated steady-state input conditions were established.

Logic Diagram



Absolute Maximum Ratings(Note 4)

Recommended Operating Conditions (Note 6)

-0.5V to +4.6V Supply Voltage (V_{CC}) -0.5V to +4.6V DC Input Voltage (V_I)

DC Output Voltage (V_O)

Outputs 3-STATE -0.5V to +4.6VOutputs Active (Note 5) -0.5V to $V_{CC} + 0.5V$

DC Output Sink Current into

A Port I_{OL} 48 mA

DC Output Source Current from

A Port I_{OH} -48 mA

DC Output Sink Current into

B Port in the LOW State, I_{OL} 100 mA DC Input Diode Current (I_{IK})

 $V_{I} < 0V$ -50 mA DC Output Diode Current (I_{OK})

 $V_O < 0V$ -50 mA $V_{O} > V_{CC}$ +50 mA **ESD** Performance >2000V

Storage Temperature (T_{STG}) -65°C to +150°C

Supply Voltage V_{CC}/V_{CCQ} 3.15V to 3.45V

Bus Termination Voltage (V_{TT})

GTLP 1.47V to 1.53V 0.98V to 1.02V V_{REF}

Input Voltage (V_I)

on A Port and Control Pins 0.0V to 3.45V

on B Port 0.0V to 3.45V

HIGH Level Output Current (I_{OH})

-24 mA

LOW Level Output Current (I_{OL})

A Port +24 mA B Port +50 mA

-40°C to +85°C Operating Temperature (T_A)

Note 4: Absolute Maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute maximum rated conditions in not

Note 5: I_O Absolute Maximum Rating must be observed. Note 6: Unused inputs must be held HIGH or LOW.

DC Electrical Characteristics

Over Recommended Operating Free-Air Temperature Range, $V_{REF} = 1.0V$ (unless otherwise noted).

Symbol		Test Conditio	Test Conditions		Typ (Note 7)	Max	Units	
V _{IH}	B Port			V _{REF} +0.05		V _{TT}	V	
	Others			2.0			V	
V _{IL}	B Port			0.0		V _{REF} - 0.05	V	
	Others					0.8	V	
V _{REF}	GTLP (Note 8)				1.0		V	
	GTL				0.8		V	
V _{IK}		V _{CC} = 3.15V	$I_I = -18 \text{ mA}$			-1.2	V	
V _{OH}	A Port	V _{CC} , V _{CCQ} = Min to Max (Note 9)	$I_{OH} = -100 \mu A$	V _{CC} -0.2				
		V _{CC} = 3.15V	$I_{OH} = -8 \text{ mA}$	2.4			V	
			I _{OH} = -24mA	2.0				
V _{OL}	A Port	V _{CC} , V _{CCQ} = Min to Max (Note 9)	$I_{OL} = 100 \mu A$			0.2	٧	
		V _{CC} = 3.15V	I _{OL} = 24mA			0.5		
	B Port	V _{CC} = 3.15V	I _{OL} = 40 mA			0.40	V	
			I _{OL} = 50 mA			0.55	V	
T _I	Control Pins	V _{CC} = Min to Max (Note 9)	$V_I = 3.45V \text{ or } 0V$			±5	μΑ	
	A Port	V _{CC} = 3.45V	$V_I = 0V$			-10		
			$V_{I} = 3.45$			10	μА	
	B Port	V _{CC} = 3.45V	$V_I = V_{CC}$			5	μА	
			V _I = 0			-5	μА	
I _{OFF}	A Port and Control Pins	V _{CC} = 0	V_{I} or $V_{O} = 0$ to 3.45V			30	μΑ	
I _{I(hold)}	A Port	V _{CC} = 3.15V	$V_I = 0.8V$	75				
			$V_I = 2.0V$			-75	μΑ	
I _{OZH}	A Port	V _{CC} = 3.45V	V _O = 3.45			10		
	B Port	1	$V_0 = 1.5V$			5	μА	
I _{OZL}	A Port	V _{CC} = 3.45V	$V_O = 0V$		-10			
	B Port	1	V _O = 0.55V			-5	μA	

DC Electrical Characteristics (Continued)

Symbol		Test Condition	Min	Typ (Note 7)	Max	Units	
I _{CC}	A or B Ports	V _{CC} = 3.45V	Outputs HIGH		30	40	
(V_{CC}/V_{CCQ})		$I_O = 0$	Outputs LOW		30	40	mA
		$V_I = V_{CC}$ or GND	Outputs Disabled		30	45	
ΔI_{CC}	A Port and	V _{CC} = 3.45V,	One Input at 2.7V		0	2	mA
(Note 10)	Control Pins	A or Control Inputs at V_{CC} or GND					
C _i	Control Pins		$V_I = V_{CC}$ or 0		6		
	A Port		$V_I = V_{CC}$ or 0		7.5		pF
	B Port		$V_I = V_{CC}$ or 0		9.0		

Note 7: All typical values are at $V_{CC} = 3.3V$, $V_{CCQ} = 3.3V$, and $T_A = 25$ °C.

Note 8: GTLP V_{REF} and V_{TT} are specified to 2% tolerance since signal integrity and noise margin can be significantly degraded if these supplies are noisy. In addition, V_{TT} and Rterm can be adjusted beyond the recommended operating conditions to accommodate backplane impedances other than 50 Ω , but must remain within the boundaries of the DC Absolute Maximum ratings. Similarly V_{REF} can be adjusted to optimize noise margin.

Note 9: For conditions shown as Min or Max, use the appropriate value specified under recommended operating conditions.

Note 10: This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

AC Operating Requirements

Over recommended ranges of supply voltage and operating free-air temperature, $V_{REF} = 1.0V$ (unless otherwise noted).

Symbol		Test Conditions	Min	Max	Unit
f _{CLOCK}	Maximum Clock Frequency		0	175	MHz
t _{WIDTH}	Pulse Duration	LEAB or LEBA HIGH	3.0		ns
		CLKAB or CLKBA HIGH or LOW	3.0		115
t _{SU}	Setup Time	A before CLKAB↑	1.1		
		B before CLKBA↑	3.0		
		A before LEAB	1.1		1
		B before LEBA	2.7		ns
		CEAB before CLKAB↑	1.2		
		CEBA before CLKBA↑	1.4		
t _{HOLD}	Hold Time	A after CLKAB↑	0.0		
		B after CLKBA↑	0.0		1
		A after LEAB	0.8		
		B after LEBA	0.0		ns
		CEAB after CLKAB↑	1.0		1
		CEBA after CLKBA↑	1.9		1

AC Electrical Characteristics

Over recommended range of supply voltage and operating free-air temperature, $V_{REF} = 1.0V$ (unless otherwise noted). $C_L = 30$ pF for B Port and $C_L = 50$ pF for A Port.

Symbol	From (Input)	To (Output)	Min	Typ (Note 11)	Max	Unit
t _{PLH}	A	В	2.1	4.1	6.3	
PHL			1.0	2.7	4.4	ns
PLH	LEAB	В	2.2	4.2	6.3	
PHL			1.0	2.4	4.2	ns
PLH	CLKAB	В	2.2	4.4	6.5	
t _{PHL}			1.0	2.5	4.4	ns
t _{PLH}	OEAB	В	2.0	3.8	5.6	
^t PHL			1.0	2.6	4.3	ns
t _{RISE}	Transition time, B o	utputs (20% to 80%)		3.1		
t _{FALL}	Transition time, B o		2.1		ns	
t _{PLH}	В	Α	1.8	3.8	5.8	no
t _{PHL}			1.8	3.8	5.8	ns
t _{PLH}	LEBA	A	0.3	2.2	4.6	no
t _{PHL}			0.4	2.4	4.6	ns
t _{PLH}	CLKBA	A	0.5	2.4	4.6	no
t _{PHL}			0.6	2.6	4.6	ns
t _{PZH} , t _{PZL}	OEBA	A	0.3	2.7	5.2	
t _{PHZ} , t _{PLZ}			0.3	2.5	5.2	ns

Note 11: All typical values are at $V_{CC}=3.3V$, and $T_A=25^{\circ}C$.

Extended Electrical Characteristics

Over recommended ranges of supply voltage and operating free-air temperature $V_{REF} = 1.0V$ (unless otherwise noted). $C_L = 30$ pF for B Port and $C_L = 50$ pF for A Port.

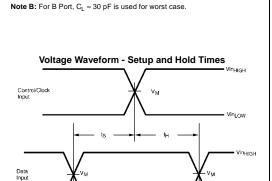
Symbol	From (Input)	To (Output)	Min	Typ (Note 11)	Max	Unit
t _{OSLH} (Note 12)	A	В		0.8	1.0	ns
t _{OSHL} (Note 12)				0.3	0.5	ns
t _{PV(HL)} (Note 13)(Note 14)	Α	В			0.8	ns
t _{OSLH} (Note 12)	CLKAB	В		0.9	1.0	ns
t _{OSHL} (Note 12)				0.3	0.5	ns
t _{PV(HL)} (Note 13)(Note 14)	CLKAB	В			0.8	ns
t _{OSLH} (Note 12)	В	А		0.7	1.0	ns
t _{OSHL} (Note 12)				0.6	1.0	ns
t _{OST} (Note 12)	В	Α		0.7	1.1	ns
t _{PV} (Note 13)	В	A			1.5	ns
t _{OSLH} (Note 12)	CLKAB	A		0.5	1.0	ns
t _{OSHL} (Note 12)				0.6	1.0	ns
t _{OST} (Note 12)	CLKAB	Α		1.1	1.2	ns
t _{PV} (Note 13)	CLKAB	Α			1.5	ns

Note 12: t_{OSHL}/t_{OSLH} and t_{OST} - Output to output skew is defined as the absolute value of the difference between the actual propagation delay for all outputs within the same packaged device. The specifications are given for specific worst case V_{CC} and temperature and apply to any outputs switching in the same direction either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}) or in opposite directions both HL and LH (t_{OST}). This parameter is guaranteed by design and statistical process distribution. Actual skew values between the GTLP outputs could vary on the backplane due to the loading and impedance seen by the device.

Note 13: t_{PV} - Part to part skew is defined as the absolute value of the difference between the actual propagation delay for all outputs from device to device. The parameter is specified for a specific worst case V_{CC} and temperature. This parameter is guaranteed by design and statistical process distribution. Actual skew values between the GTLP outputs could vary on the backplane due to the loading and impedance seen by the device.

Note 14: Due to the open drain structure on GTLP outputs t_{OST} and $t_{PV(LH)}$ in the A-to-B direction are not specified. Skew on these paths is dependent on the V_{TT} and R_T values on the backplane.

Test Circuits and Timing Waveforms Test Circuit for A Outputs , **o** 6V O Open Output Under **Q** GND 500Ω Test S t_{PLH}/t_{PHL} Open t_{PLZ}/t_{PZL} t_{PHZ}/t_{PZH} Note A: C_L includes probes and Jig capacitance **Voltage Waveform - Propagation Delay Times** VinLOW tpLH or tpHL



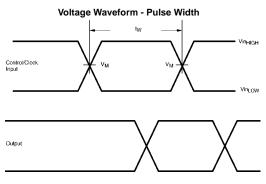
Test Circuit for B Outputs

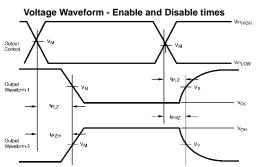
Output

Under

1.5V (GTLP) 1.2V (GTL)

₹ 25Ω





Output Waveform 1 is for an output with internal conditions such that the output is LOW except when disabled by the control output.

Output Waveform 2 is for an output with internal conditions such that the output is HIGH except when disabled by the control output.

Input and Measure Conditions

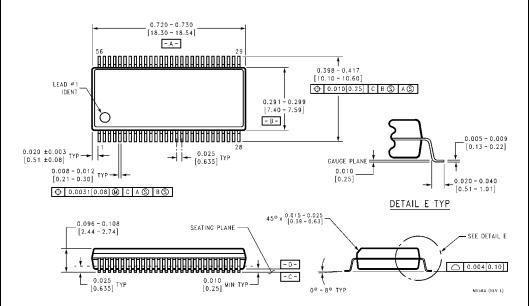
	A or LVTTL Pins	B or GTLP Pins
V_{inHIGH}	3.0	1.5
V_{inLOW}	0.0	0.0
V _M	1.5	1.0
V _X	V _{OL} + 0.3V	N/A
V _Y	V _{OH} – 0.3V	N/A

All input pulses have the following characteristics: Frequency = 10MHz, $t_{RISE} = t_{FALL} = 2$ ns (10% to 90%), $Z_{O} = 50\Omega$. The outputs are measured one at a time with one transition per measurement.

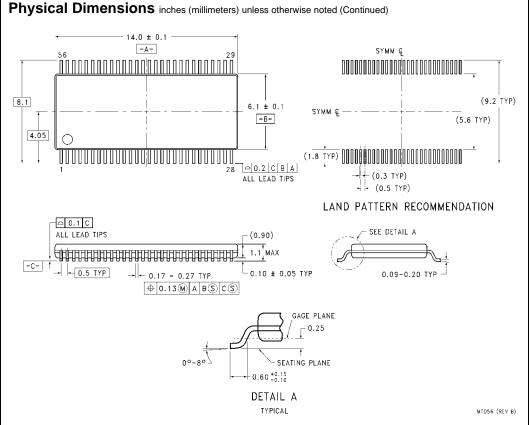
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Output

Physical Dimensions inches (millimeters) unless otherwise noted



56-Lead Shrink Small Outline Package (SSOP), JEDEC MO-118, 0.300" Wide Package Number MS56A



56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide Package Number MTD56

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